## FEATURES

Operation from 1800 MHz to 2700 MHz
Gain of 24.3 dB at 2140 MHz
OIP3 of 45.5 dBm at 2140 MHz
P1dB of 30.8 dBm at 2140 MHz
Noise figure of $\mathbf{4 . 7} \mathbf{~ d B}$ at $2140 \mathbf{~ M H z}$
Power supply: 5 V
Power supply current: 362 mA typical
Internal active biasing
Fast power-up/power-down function
Compact $4 \mathrm{~mm} \times 4 \mathrm{~mm}, 16$-lead LFCSP
ESD rating of $\pm 1 \mathrm{kV}$ (Class 1C)
Pin-compatible with the ADL5605 ( $\mathbf{7 0 0} \mathbf{~ M H z}$ to 1000 MHz)

## APPLICATIONS

## Wireless infrastructure

Automated test equipment
ISM/AMR applications

## GENERAL DESCRIPTION

The ADL5606 is a broadband, two-stage, 1 W RF driver amplifier that operates over a frequency range of 1800 MHz to 2700 MHz . The device can be used in a wide variety of wired and wireless applications, including ISM, MC-GSM, W-CDMA, TD-SCDMA, and LTE.
The ADL5606 operates on a 5 V supply voltage and a supply current of 362 mA . The driver also incorporates a fast power-up/power-down function for TDD applications, applications that require a power saving mode, and applications that intermittently transmit data.

The ADL5606 is fabricated on a GaAs HBT process and is packaged in a compact $4 \mathrm{~mm} \times 4 \mathrm{~mm}$, 16-lead LFCSP that uses an exposed paddle for excellent thermal impedance. The ADL5606 operates from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$. A fully populated evaluation board tuned to 2140 MHz is also available.

Rev. C

FUNCTIONAL BLOCK DIAGRAM



Figure 2. ACPR vs. Output Power, 3GPP, TM1-64, at 2140 MHz

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5/2020—Rev. B to Rev. C
Changes to Figure 35 ..... 14
9/2017—Rev. A to Rev. B
Changed CP-16-10 to CP-16-20

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## SPECIFICATIONS

VCC1 $=5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted. ${ }^{1}$
Table 1.

| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OVERALL FUNCTION Frequency Range |  | 1800 |  | 2700 | MHz |
| ```FREQUENCY \(=1960 \mathrm{MHz} \pm 30 \mathrm{MHz}\) Gain vs. Frequency vs. Temperature vs. Supply Output 1 dB Compression Point (P1dB) vs. Frequency vs. Temperature vs. Supply Adjacent Channel Power Ratio (ACPR) Output Third-Order Intercept (OIP3) vs. Frequency vs. Temperature vs. Supply Noise Figure``` | $\begin{aligned} & \pm 30 \mathrm{MHz} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & 4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V} \\ & \pm 30 \mathrm{MHz} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & 4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V} \\ & \text { Pout }=18 \mathrm{dBm} \text {, one-carrier W-CDMA, } 64 \mathrm{DPCH} \\ & \Delta \mathrm{f}=1 \mathrm{MHz}, \text { Pout }=14 \mathrm{dBm} \text { per tone } \\ & \pm 30 \mathrm{MHz} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & 4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & 24.7 \\ & \pm 0.5 \\ & \pm 0.9 \\ & \pm 0.05 \\ & 30.2 \\ & +0.2 /-0.6 \\ & \pm 0.5 \\ & \pm 0.5 \\ & 52 \\ & 45.6 \\ & +0.8 /-0.2 \\ & +0.0 /-2.2 \\ & \pm 0.5 \\ & 5.1 \end{aligned}$ |  | dB <br> dB <br> dB <br> dB <br> dBm <br> dB <br> dB <br> dB <br> dBc <br> dBm <br> dB <br> dB <br> dB <br> dB |
| ```FREQUENCY = 2140 MHz \pm 30 MHz Gain vs. Frequency vs. Temperature vs. Supply Output 1 dB Compression Point (P1dB) vs. Frequency vs. Temperature vs. Supply Adjacent Channel Power Ratio (ACPR) Output Third-Order Intercept (OIP3) vs. Frequency vs. Temperature vs. Supply Noise Figure``` | $\begin{aligned} & \pm 30 \mathrm{MHz} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & 4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V} \\ & \pm 30 \mathrm{MHz} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & 4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V} \\ & \text { Pout }=18 \mathrm{dBm} \text {, one-carrier W-CDMA, } 64 \mathrm{DPCH} \\ & \Delta \mathrm{f}=1 \mathrm{MHz}, \text { Pout }=14 \mathrm{dBm} \text { per tone } \\ & \pm 30 \mathrm{MHz} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & 4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & 24.3 \\ & +0.4 /-0.1 \\ & \pm 0.9 \\ & \pm 0.06 \\ & 30.8 \\ & \pm 0.5 \\ & \pm 0.8 \\ & \pm 0.4 \\ & 51 \\ & 45.5 \\ & +2.3 /-0.8 \\ & +0.0 /-2.5 \\ & +0.6 /-0.3 \\ & 4.7 \end{aligned}$ |  | dB <br> dB <br> dB <br> dB <br> dBm <br> dB <br> dB <br> dB <br> dBc <br> dBm <br> dB <br> dB <br> dB <br> dB |
| ```FREQUENCY = 2630 MHz \pm60 MHz Gain vs. Frequency vs. Temperature vs. Supply Output 1 dB Compression Point (P1dB) vs. Frequency vs. Temperature vs. Supply Output Third-Order Intercept (OIP3) vs. Frequency vs. Temperature vs.Supply Noise Figure``` | $\begin{aligned} & \pm 60 \mathrm{MHz} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & 4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V} \\ & \\ & \pm 60 \mathrm{MHz} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & 4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V} \\ & \Delta \mathrm{f}=1 \mathrm{MHz}, \text { Pout }=14 \mathrm{dBm} \text { per tone } \\ & \pm 60 \mathrm{MHz} \\ & -40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C} \\ & 4.75 \mathrm{~V} \text { to } 5.25 \mathrm{~V} \end{aligned}$ |  | $\begin{aligned} & 20.6 \\ & +0.7 /-1.8 \\ & \pm 1.0 \\ & \pm 0.09 \\ & 28.9 \\ & +0.5 /-1.7 \\ & +1.2 /-2.0 \\ & \pm 0.2 \\ & 43.2 \\ & \pm 3.0 \\ & +0.3 /-4.0 \\ & \pm 1.9 \\ & 5.1 \end{aligned}$ |  | dB <br> dB <br> dB <br> dB <br> dBm <br> dB <br> dB <br> dB <br> dBm <br> dB <br> dB <br> dB <br> dB |

## ADL5606

| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| POWER-DOWN INTERFACE | DISABLE pin |  |  |  |  |
| Logic Level to Enable | VIISABLE decreasing |  | 0 | 1.1 | V |
| Logic Level to Disable | VIISAble increasing | 1.4 | 5 |  | V |
| DISABLE Pin Current | $\mathrm{V}_{\text {disable }}=5 \mathrm{~V}$ |  | 1.4 |  | mA |
| VCC1 Pin Current ${ }^{1}$ | $\mathrm{V}_{\text {disable }}=5 \mathrm{~V}$ |  | 4.2 |  | mA |
| Enable Time | 10\% of control pulse to $90 \%$ of RFOUT |  | 75 |  | ns |
| Disable Time | $10 \%$ of control pulse to $90 \%$ of RFOUT |  | 20 |  | ns |
| POWER INTERFACE | RFOUT pin |  |  |  |  |
| Supply Voltage |  | 4.75 | 5 | 5.25 | V |
| Supply Current |  |  | 362 | 390 | mA |
| vs. Temperature | $-40^{\circ} \mathrm{C} \leq \mathrm{T}_{\mathrm{A}} \leq+85^{\circ} \mathrm{C}$ |  | +0/-25 |  | mA |

${ }^{1}$ VCC1 is the supply to the DUT through the RFOUT pins.

## TYPICAL SCATTERING PARAMETERS

$\mathrm{VCC}=5 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$; the effects of the test fixture have been de-embedded up to the pins of the device. ${ }^{1}$
Table 2.

| $\begin{aligned} & \text { Frequency } \\ & \text { (MHz) } \end{aligned}$ | S11 |  | S21 |  | S12 |  | S22 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Magnitude (dB) | Angle ( ${ }^{\circ}$ ) | Magnitude (dB) | Angle ( ${ }^{\circ}$ ) | Magnitude (dB) | Angle ( ${ }^{\circ}$ ) | Magnitude (dB) | Angle ( ${ }^{\circ}$ ) |
| 1000 | -5.94 | 1.63 | 25.77 | 42.78 | -64.90 | 91.56 | -1.68 | 179.86 |
| 1050 | -7.09 | -24.39 | 25.28 | 25.40 | -63.13 | 114.08 | -1.63 | 179.29 |
| 1100 | -7.74 | -48.66 | 24.68 | 10.90 | -58.63 | 108.53 | -1.54 | 178.87 |
| 1150 | -7.94 | -69.86 | 23.97 | -1.40 | -58.57 | 98.35 | -1.53 | 178.32 |
| 1200 | -7.82 | -87.28 | 23.32 | -12.01 | -59.58 | 114.37 | -1.53 | 177.95 |
| 1250 | -7.46 | -100.72 | 22.71 | -21.44 | -55.02 | 106.02 | -1.46 | 177.27 |
| 1300 | -7.06 | -111.67 | 22.14 | -29.87 | -52.50 | 102.74 | -1.45 | 176.60 |
| 1350 | -6.70 | -120.51 | 21.64 | -37.10 | -54.05 | 91.45 | -1.43 | 176.34 |
| 1400 | -6.38 | -126.95 | 21.16 | -44.03 | -53.01 | 111.40 | -1.39 | 175.90 |
| 1450 | -6.08 | -133.47 | 20.75 | -50.61 | -51.79 | 83.98 | -1.35 | 175.36 |
| 1500 | -5.76 | -138.12 | 20.33 | -56.84 | -53.89 | 111.28 | -1.38 | 174.93 |
| 1550 | -5.47 | -142.70 | 19.98 | -62.62 | -53.41 | 117.99 | -1.35 | 174.51 |
| 1600 | -5.24 | -146.61 | 19.67 | -68.33 | -53.37 | 76.10 | -1.34 | 174.16 |
| 1650 | -5.02 | -150.10 | 19.36 | -73.72 | -51.35 | 87.47 | -1.30 | 173.84 |
| 1700 | -4.76 | -153.11 | 19.07 | -79.01 | -50.65 | 92.39 | -1.26 | 173.35 |
| 1750 | -4.58 | -155.89 | 18.79 | -83.92 | -50.70 | 83.18 | -1.24 | 173.01 |
| 1800 | -4.42 | -158.41 | 18.52 | -88.97 | -51.02 | 92.52 | -1.23 | 172.59 |
| 1850 | -4.25 | -160.75 | 18.28 | -93.94 | -50.59 | 93.13 | -1.23 | 172.28 |
| 1900 | -4.11 | -162.84 | 18.01 | -98.66 | -50.81 | 82.49 | -1.21 | 171.75 |
| 1950 | -3.97 | -164.79 | 17.78 | -103.29 | -50.52 | 90.57 | -1.18 | 171.61 |
| 2000 | -3.82 | -166.56 | 17.56 | -107.86 | -52.43 | 75.32 | -1.19 | 171.19 |
| 2050 | -3.72 | -168.58 | 17.34 | -112.42 | -49.77 | 80.61 | -1.17 | 170.99 |
| 2100 | -3.61 | -170.35 | 17.13 | -116.91 | -50.35 | 81.31 | -1.16 | 170.70 |
| 2150 | -3.50 | -172.01 | 16.90 | -121.14 | -49.72 | 83.35 | -1.16 | 170.44 |
| 2200 | -3.42 | -173.71 | 16.68 | -125.59 | -50.21 | 87.74 | -1.16 | 170.09 |
| 2250 | -3.36 | -175.63 | 16.47 | -129.80 | -47.59 | 82.95 | -1.17 | 169.84 |
| 2300 | -3.28 | -177.44 | 16.27 | -134.15 | -47.62 | 88.25 | -1.14 | 169.46 |
| 2350 | -3.23 | -179.05 | 16.02 | -138.14 | -48.93 | 79.29 | -1.16 | 169.27 |
| 2400 | -3.23 | 179.33 | 15.79 | -142.35 | -49.37 | 83.50 | -1.18 | 169.01 |
| 2450 | -3.19 | 177.86 | 15.58 | -146.40 | -48.09 | 75.23 | -1.18 | 168.72 |
| 2500 | -3.15 | 176.27 | 15.37 | -150.40 | -47.72 | 78.72 | -1.16 | 168.34 |
| 2550 | -3.17 | 174.60 | 15.15 | -154.46 | -47.40 | 76.72 | -1.18 | 168.15 |


| $\begin{aligned} & \text { Frequency } \\ & \text { (MHz) } \\ & \hline \end{aligned}$ | S11 |  | S21 |  | S12 |  | S22 |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Magnitude (dB) | Angle ( ${ }^{\circ}$ ) | Magnitude (dB) | Angle ( ${ }^{\circ}$ ) | Magnitude (dB) | Angle ( ${ }^{\circ}$ ) | Magnitude (dB) | Angle ( ${ }^{\circ}$ ) |
| 2600 | -3.14 | 172.86 | 14.92 | -158.40 | -46.51 | 77.12 | -1.20 | 167.77 |
| 2650 | -3.14 | 171.24 | 14.70 | -162.27 | -47.66 | 73.90 | -1.20 | 167.47 |
| 2700 | -3.12 | 169.74 | 14.48 | -166.06 | -47.77 | 71.80 | -1.22 | 167.16 |
| 2750 | -3.14 | 167.93 | 14.24 | -169.97 | -45.35 | 73.70 | -1.22 | 166.68 |
| 2800 | -3.16 | 166.21 | 13.98 | -173.76 | -45.43 | 76.05 | -1.24 | 166.34 |
| 2850 | -3.15 | 164.65 | 13.78 | -177.32 | -46.35 | 71.78 | -1.25 | 166.25 |
| 2900 | -3.15 | 162.67 | 13.53 | 178.93 | -46.92 | 73.31 | -1.26 | 165.90 |
| 2950 | -3.15 | 160.86 | 13.27 | 175.30 | -45.88 | 70.64 | -1.30 | 165.58 |
| 3000 | -3.14 | 159.03 | 13.04 | 171.76 | -45.94 | 66.79 | -1.29 | 165.35 |
| 3050 | -3.13 | 157.22 | 12.79 | 168.32 | -45.60 | 73.37 | -1.33 | 165.06 |
| 3100 | -3.08 | 155.39 | 12.57 | 165.01 | -44.06 | 61.32 | -1.35 | 164.76 |
| 3150 | -3.01 | 152.90 | 12.32 | 161.32 | -45.54 | 58.34 | -1.36 | 164.32 |
| 3200 | -3.08 | 150.72 | 12.04 | 157.39 | -46.51 | 60.72 | -1.36 | 163.65 |
| 3250 | -3.06 | 149.25 | 11.78 | 153.80 | -43.87 | 61.02 | -1.35 | 163.38 |
| 3300 | -3.05 | 147.28 | 11.53 | 150.59 | -44.31 | 68.64 | -1.36 | 162.94 |
| 3350 | -3.03 | 145.53 | 11.20 | 147.57 | -44.17 | 62.82 | -1.39 | 162.61 |
| 3400 | -2.94 | 143.76 | 10.95 | 144.00 | -43.67 | 64.76 | -1.39 | 162.08 |
| 3450 | -2.95 | 141.94 | 10.65 | 141.12 | -44.65 | 72.58 | -1.39 | 161.92 |
| 3500 | -2.85 | 140.04 | 10.39 | 137.78 | -44.52 | 53.43 | -1.38 | 161.39 |
| 3550 | -2.83 | 138.58 | 10.10 | 134.68 | -44.22 | 63.44 | -1.35 | 161.11 |
| 3600 | -2.79 | 136.47 | 9.83 | 131.38 | -43.79 | 46.56 | -1.36 | 160.74 |
| 3650 | -2.74 | 134.67 | 9.55 | 128.32 | -42.04 | 50.76 | -1.31 | 160.48 |
| 3700 | -2.78 | 132.80 | 9.25 | 125.07 | -43.97 | 57.92 | -1.33 | 160.24 |
| 3750 | -2.80 | 130.85 | 8.94 | 121.74 | -42.96 | 49.24 | -1.30 | 159.79 |
| 3800 | -2.87 | 128.85 | 8.63 | 119.06 | -43.01 | 51.05 | -1.30 | 159.68 |
| 3850 | -3.03 | 126.98 | 8.30 | 115.71 | -41.84 | 45.82 | -1.24 | 159.28 |
| 3900 | -3.24 | 125.26 | 7.90 | 113.11 | -41.50 | 36.66 | -1.26 | 159.17 |
| 3950 | -3.63 | 123.34 | 7.59 | 110.08 | -42.15 | 39.82 | -1.20 | 159.15 |
| 4000 | -4.24 | 122.71 | 7.15 | 108.11 | -41.81 | 41.17 | -1.21 | 159.19 |

${ }^{1}$ VCC1 is the supply to the DUT through the RFOUT pins.

## ABSOLUTE MAXIMUM RATINGS

Table 3.

| Parameter | Rating |
| :--- | :--- |
| Supply Voltage, $\mathrm{VCC1} 1$ | 6.5 V |
| Input Power (50 $\Omega$ Impedance) | 18 dBm |
| Internal Power Dissipation (Paddle | 3.5 W |
| Soldered) |  |
| Maximum Junction Temperature | $150^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering 60 sec ) | $240^{\circ} \mathrm{C}$ |
| Operating Temperature Range | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

${ }^{1}$ VCC1 is the supply to the DUT through the RFOUT pins.
Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied.
Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

Table 4 lists the junction-to-air thermal resistance $\left(\theta_{J A}\right)$ and the junction-to-paddle thermal resistance $\left(\theta_{\text {JC }}\right)$ for the ADL5606.
For more information, see the Thermal Considerations section.
Table 4. Thermal Resistance

| Package Type | $\boldsymbol{\theta}_{\mathrm{JA}}$ | $\boldsymbol{\theta}_{\mathrm{Jc}}$ | Unit |
| :--- | :--- | :--- | :--- |
| 16-Lead LFCSP (CP-16-20) | 52.9 | 12.9 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## ESD CAUTION

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Table 5. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
| :--- | :--- | :--- |
| 1 | RFIN | RF Input. Requires a dc blocking capacitor. |
| 2 | DISABLE | Connect this pin to 5 V to disable the part. In the disabled state, the part draws approximately 4 mA <br> of current from the power supply and 1.4 mA from the DISABLE pin. <br> Under normal operation, this pin is connected to the power supply and draws a combined 362 mA <br> of current. When this pin is grounded along with the VBIAS pin, the device is disabled and draws <br> approximately 1.4 mA from the DISABLE pin. <br> Applying 5 V to this pin enables the bias circuit. When this pin is grounded, the device is disabled. |
| 4 <br> $5,6,7,8,13$, <br> $14,15,16$ <br> $9,10,11,12$ | VFOUT | NC |
| No Connect. Do not connect to this pin. |  |  |
| RF Output. DC bias is provided to this pin through an inductor that is connected to the 5 V power |  |  |
| supply. The RF path requires a dc blocking capacitor. |  |  |
| The exposed paddle should be soldered to a low impedance electrical and thermal ground plane. |  |  |

## ADL5606

## TYPICAL PERFORMANCE CHARACTERISTICS

## 1960 MHZ FREQUENCY TUNING BAND



Figure 4. Noise Figure, Gain, P1dB, and OIP3 vs. Frequency (OIP3 at Pout $=14 \mathrm{dBm}$ per Tone)


Figure 5. Gain vs. Frequency and Temperature


Figure 6. Input Return Loss (S11), Output Return Loss (S22), and Reverse Isolation (S12) vs. Frequency


Figure 7. P1dB and OIP3 vs. Frequency and Temperature (OIP3 at Pout $=14 \mathrm{dBm}$ per Tone)


Figure 8. OIP3 vs. Pout and Frequency


Figure 9. Noise Figure vs. Frequency and Temperature

## 2140 MHZ FREQUENCY TUNING BAND



Figure 10. Noise Figure, Gain, P1dB, and OIP3 vs. Frequency (OIP3 at Pout $=14 \mathrm{dBm}$ per Tone)


Figure 11. Gain vs. Frequency and Temperature


Figure 12. Input Return Loss (S11), Output Return Loss (S22), and Reverse Isolation (S12) vs. Frequency


Figure 13. P1dB and OIP3 vs. Frequency and Temperature
(OIP3 at Pout $=14 \mathrm{dBm}$ per Tone)


Figure 14. OIP3 vs. Pout and Frequency


Figure 15. Noise Figure vs. Frequency and Temperature

## ADL5606

## 2630 MHZ FREQUENCY TUNING BAND



Figure 16. Noise Figure, Gain, P1dB, and OIP3 vs. Frequency
(OIP3 at Pout $=14 \mathrm{dBm}$ per Tone)


Figure 17. Gain vs. Frequency and Temperature


Figure 18. Input Return Loss (S11), Output Return Loss (S22), and Reverse Isolation (S12) vs. Frequency


Figure 19. P1dB and OIP3 vs. Frequency and Temperature (OIP3 at Pout $=14 \mathrm{dBm}$ per Tone)


Figure 20. OIP3 vs. Pout and Frequency


Figure 21. Noise Figure vs. Frequency and Temperature

## GENERAL



Figure 22. OIP3 Distribution at $2140 \mathrm{MHz}, 14 \mathrm{dBm}$ per Tone


Figure 23. P1dB Distribution at 2140 MHz


Figure 24. Gain Distribution at 2140 MHz


Figure 25. Noise Figure Distribution at 2140 MHz


Figure 26. ACPR vs. Pout, 3GPP, TM1-64, at 1960 MHz and 2140 MHz


Figure 27. EVM vs. Pout, 3GPP, TM1-64, at 1960 MHz and 2140 MHz


Figure 28. Supply Current vs. Temperature and Supply Voltage at 2140 MHz


Figure 29. Supply Current vs. Pout and Temperature at $2140 \mathrm{MHz}, ~ V C C=5 \mathrm{~V}$


Figure 30. Turn-Off Time, 10\% of Control Pulse to $90 \%$ of RFOUT


Figure 31. Turn-On Time, 10\% of Control Pulse to $90 \%$ of RFOUT

## APPLICATIONS INFORMATION <br> BASIC LAYOUT CONNECTIONS

The basic connections for operating the ADL5606 are shown in Figure 32. The RF matching components correspond to the 2140 MHz frequency tuning band.

## Power Supply

The voltage supply for the ADL5606, which ranges from 4.75 V to 5.25 V , should be connected to the VCC1 test pin. The dc bias to the output stage is supplied through L 1 and is connected to the RFOUT pin. Three decoupling capacitors (C7, C8, and C9) are used to prevent RF signals from propagating on the dc lines. The VBIAS and VCC pins can be directly connected to the main supply voltage. Additional decoupling capacitors (C5, C6, and $\mathrm{C} 11)$ are required on the VCC pin.

## RF Input Interface

Pin 1 is the RF input pin for the ADL5606. The RF input is easily matched with one capacitor, in a series or shunt configuration, and a microstrip line used as an inductor. For the 1960 MHz and 2140 MHz frequency tuning bands, a shunt capacitor is used to match the input to $50 \Omega$; for the 2630 MHz frequency tuning band, a series capacitor is used.

For complete information about component values and spacing for the different frequency tuning bands, see the ADL5606 Matching section.

## RF Output Interface

Pin 9 to Pin 12 are the RF output pins. The RF output requires only one shunt capacitor and a microstrip line used as an inductor to match to $50 \Omega$. For complete information about component values and spacing for the different frequency tuning bands, see the ADL5606 Matching section.

## Power-Down

The ADL5606 can be disabled by connecting the DISABLE pin to 5 V . When disabled, the ADL5606 draws approximately 4 mA of current from the power supply and 1.4 mA from the DISABLE pin. Decoupling Capacitor C3 is recommended to prevent the propagation of RF signals. To completely shut down the device, connect the VCC pin, the VBIAS pin, and the VCC1 test pin to ground. In this state, the part draws approximately 1.4 mA from the DISABLE pin.


Figure 32. Basic Connections

## ADL5606

## ADL5606 MATCHING

The RF input and output of the ADL5606 can be easily matched to $50 \Omega$ with at most one external component and the microstrip line used as an inductor. Table 6 lists the required matching component values. Capacitors $\mathrm{C}_{\mathbb{N}}$ and Cout are Murata GRM155 series (0402 size).

For all frequency tuning bands, the placement of $\mathrm{C}_{\mathrm{IN}}$ and Cout is critical. Table 7 lists the recommended component spacing for the various frequency tuning bands. The component spacing is referenced from the center of the component to the edge of the package.
Figure 33 to Figure 35 show the matching networks.

Table 6. Recommended Components for Basic Connections

| Frequency (MHz) | CiN $^{\mathbf{I N}}$ (pF) | Cout $^{\text {(pF) }}$ |
| :--- | :--- | :--- |
| 1930 to 1990 | 2.0 | 3.6 |
| 2110 to 2170 | 1.3 | 3.9 |
| 2570 to 2690 | 2.0 | 3.3 |

Table 7. Matching Component Spacing

| Frequency (MHz) | $\boldsymbol{\lambda 1}$ (mils) | $\boldsymbol{\lambda} \mathbf{2}$ (mils) |
| :--- | :--- | :--- |
| 1930 to 1990 | 394 | 197 |
| 2110 to 2170 | 268 | 138 |
| 2570 to 2690 | 382 | 83 |



Figure 33. ADL5606 Match Parameters, 1960 MHz Frequency Tuning Band


Figure 34. ADL5606 Match Parameters, 2140 MHz Frequency Tuning Band


Figure 35. ADL5606 Match Parameters, 2630 MHz Frequency Tuning Band

## ACPR AND EVM

All adjacent channel power ratio (ACPR) and error vector magnitude (EVM) measurements were made using a single W-CDMA carrier and Test Model 1-64.

The signal is generated by a very low ACPR source and is measured at the output by a high dynamic range spectrum analyzer. For ACPR measurements, the filter setting was chosen for low ACPR; for EVM measurements, the low EVM setting was selected. The spectrum analyzer incorporates an instrument noise correction function, and highly linear amplifiers were used to boost the power levels for ACPR measurements.
Figure 26 shows ACPR vs. Pout at 1960 MHz and 2140 MHz . For power levels up to 18 dBm , an ACPR of 50 dBc or better can be achieved at 1960 MHz and 2140 MHz .

Figure 27 shows EVM vs. Pout at 1960 MHz and 2140 MHz . The EVM measured is $0.5 \%$ for power levels up to 18 dBm at 1960 MHz and 2140 MHz . The baseline composite EVM for the signal source was approximately $0.5 \%$. When operated in the linear region, there is little or no contribution to EVM by the amplifier.

## THERMAL CONSIDERATIONS

The ADL5606 is packaged in a thermally efficient $4 \mathrm{~mm} \times$ $4 \mathrm{~mm}, 16-$ lead LFCSP. The thermal resistance from junction to air $\left(\theta_{\text {JA }}\right)$ is $52.9^{\circ} \mathrm{C} / \mathrm{W}$. The thermal resistance for the product was extracted assuming a standard 4-layer JEDEC board with 25 copper plated thermal vias. The thermal vias are filled with conductive copper paste (AE3030 with thermal conductivity of 7.8 W/mK and thermal expansion $\alpha 1$ of $4 \times 10^{-5} /{ }^{\circ} \mathrm{C}$ and $\alpha 2$ of $8.6 \times 10^{-5} /{ }^{\circ} \mathrm{C}$ ). The thermal resistance from junction to case ( $\theta_{\mathrm{JC}}$ ) is $12.9^{\circ} \mathrm{C} / \mathrm{W}$, where the case is the exposed pad of the lead frame package.

For the best thermal performance, it is recommended that as many thermal vias as possible be added under the exposed pad of the LFCSP. The thermal resistance values assume a minimum of 25 thermal vias arranged in a $5 \times 5$ array with a via diameter of 8 mils, via pad of 16 mils, and a pitch of 20 mils. The vias are plated with copper, and the drill hole is filled with a conductive copper paste.

For optimal performance, it is recommended that the thermal vias be filled with a conductive paste of the equivalent thermal conductivity specified earlier in this section; alternatively, an external heat sink can be used to dissipate heat quickly without affecting the die junction temperature. It is also recommended that the ground pattern be extended above and below the device to improve thermal efficiency (see Figure 36).

## SOLDERING INFORMATION AND RECOMMENDED PCB LAND PATTERN

Figure 36 shows the recommended land pattern for the ADL5606. To minimize thermal impedance, the exposed paddle on the $4 \mathrm{~mm} \times 4 \mathrm{~mm}$ LFCSP is soldered to a ground plane along with Pin 5 to Pin 8 and Pin 13 to Pin 16. To improve thermal dissipation, 25 thermal vias are arranged in a $5 \times 5$ array under the exposed paddle. Areas above and below the paddle are tied with regular vias. If multiple ground layers exist, they should be tied together using vias. For more information about land pattern design and layout, see the AN-772 Application Note, A Design and Manufacturing Guide for the Lead Frame Chip Scale Package (LFCSP).


## EVALUATION BOARD

The schematic of the ADL5606 evaluation board is shown in Figure 37. The evaluation board uses 25 mils wide, $50 \Omega$ traces and is made from IS410 material with a 20 mils gap to ground. The evaluation board is tuned for operation at 2140 MHz . The inputs and outputs should be ac-coupled with appropriately sized capacitors; therefore, for low frequency applications, the value of C 1 and C 2 may need to be increased. DC bias is provided to the output stage via an inductor (L1) connected to the RFOUT pin. A bias voltage of 5 V is recommended.

The evaluation board has a short, non- $50 \Omega$ line on its output to accommodate the four output pins and to allow for easier low inductance output matching. The pads for Pin 9 to Pin 12 are included on this microstrip line and are included in all matches. The evaluation board uses numbers as identifiers to aid in the placement of matching components at both the RF input and RF output of the device. Figure 38 and Figure 39 show images of the board layout.


Figure 37. Evaluation Board, 2140 MHz Frequency Tuning Band

Table 8. Evaluation Board Configuration Options, 2140 MHz Frequency Tuning Band

| Component | Function/Notes | Default Value |
| :---: | :---: | :---: |
| C1, C2 | Input/output dc blocking capacitors. | $\mathrm{C} 1, \mathrm{C} 2=20 \mathrm{pF}$ |
| $\begin{aligned} & \text { C3, C4, C5, C6, C7, } \\ & \text { C8, C9, C10, C11, } \\ & \text { C12, C13, C14 } \end{aligned}$ | Power supply decoupling capacitors. Power supply decoupling capacitors are required to filter out the high frequency noise on the power supply. The smallest capacitor should be the closest to the ADL5606. The main bias that goes through RFOUT is the most sensitive to noise because the bias is connected directly to the RF output. For the 1960 MHz and 2140 MHz frequency tuning bands, Capacitors C12, C13, and C14 are open; for the 2630 MHz frequency tuning band, it is recommended that the bypassing capacitors be added as follows: $\mathrm{C} 12=100 \mathrm{pF}, \mathrm{C} 13=0.01 \mu \mathrm{~F}$, and $\mathrm{C} 14=10 \mu \mathrm{~F}$. | $\begin{aligned} & \mathrm{C} 3=10 \mathrm{pF} \\ & \mathrm{C}, \mathrm{C} 7=100 \mathrm{pF} \\ & \mathrm{C} 6, \mathrm{C} 8=0.01 \mu \mathrm{~F} \\ & \mathrm{C} 9, \mathrm{C} 11=10 \mu \mathrm{~F} \\ & \mathrm{C} 4, \mathrm{C} 10, \mathrm{C} 12, \mathrm{C} 13, \\ & \mathrm{C} 14=\text { open } \end{aligned}$ |
| CIN | Input matching capacitor. To match the ADL5606 at the 2140 MHz frequency tuning band, Shunt Capacitor $\mathrm{C}_{\mathrm{I}}$ is required at a distance of 268 mils. If space is at a premium, an inductor can take the place of the microstrip line. | $\mathrm{C}_{\mathrm{IN}}=1.3 \mathrm{pF} \mathrm{HQ}$ |
| Cout | Output matching capacitor. Cout is set at a specific distance from the device so that the micro-strip line can act as inductance for the matching network (see Table 7). If space is at a premium, an inductor can take the place of the microstrip line. A short length of low impedance line on the output is embedded in the match. | Cout $=3.9 \mathrm{pF} \mathrm{HQ}$ |
| L1 | The main bias for the ADL5606 comes through L1 to the output stage. L1 should be high impedance for the frequency of operation while providing low resistance for the dc current. The evaluation board uses a Coilcraft ${ }^{\circledR} 0603 \mathrm{HP}-18 \mathrm{NX}$ _LU inductor; this 18 nH inductor provides some of the match at 2140 MHz . | $\mathrm{L} 1=18 \mathrm{nH}$ |
| R1, R2, R4, R5 | To provide bias to all stages through just one supply, set R1 and R2 to $0 \Omega$, and leave R4 and R5 open. To provide separate bias to stages, set R1 and R2 to open and R4 and R5 to $0 \Omega$. | $\begin{aligned} & \text { R1, R2 }=0 \Omega \\ & \text { R4, R5 }=\text { open } \\ & \hline \end{aligned}$ |
| Exposed Paddle | The paddle should be connected to both thermal and electrical ground. |  |



Figure 38. Evaluation Board Layout, Top


Figure 39. Evaluation Board Layout, Bottom

## ADL5606

## OUTLINE DIMENSIONS


*COMPLIANT TO JEDEC STANDARDS MO-220-WGGC-3 WITH EXCEPTION TO THE EXPOSED PAD.
Figure 40. 16-Lead Lead Frame Chip Scale Package [LFCSP]
$4 \mathrm{~mm} \times 4 \mathrm{~mm}$ Body and 0.75 mm Package Height (CP-16-20)
Dimensions shown in millimeters

## ORDERING GUIDE

| Model $^{1}$ | Temperature Range | Package Description | Package Option |
| :--- | :--- | :--- | :--- |
| ADL5606ACPZ-R7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $16-L e a d ~ L e a d ~ F r a m e ~ C h i p ~ S c a l e ~ P a c k a g e ~[L F C S P] ~$ <br> ADL5606-EVALZ |  |

${ }^{1} Z=$ RoHS Compliant Part.

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